TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

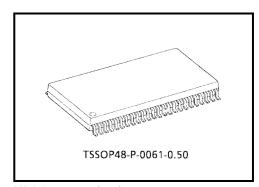
# **TC74LCX16244FT**

#### Low-Voltage 16-Bit Bus Buffer with 5-V Tolerant Inputs and Outputs

The TC74LCX16244FT is a high-performance CMOS 16-bit bus buffer. Designed for use in 2.5-V or 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

The device is designed for low-voltage (2.5-V or 3.3-V)  $_{\rm VCC}$  applications, but it could be used to interface to 5 V supply environment for both inputs and outputs.

This device is non-inverting 3-state buffer having four active-low output enables. It can be used as four 4-bit buffers two 8-bit buffers or one 16-bit buffer. When the  $\overline{\rm OE}$  input is high, the outputs are in a high-impedance state. This device is designed to be used with 3-state memory address drivers, etc.



Weight: 0.25 g (typ.)

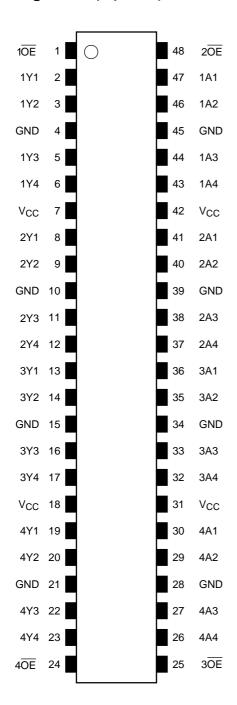
All inputs are equipped with protection circuits against static discharge.

#### **Features**

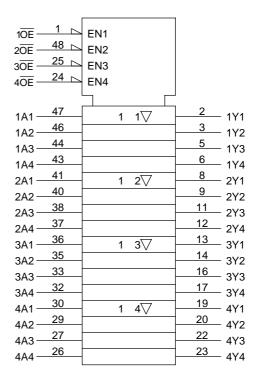
- Low-voltage operation: VCC = 2.0 to 3.6 V
- High-speed operation:  $t_{pd} = 4.5 \text{ ns (max) (VCC} = 3.0 \text{ to } 3.6 \text{ V)}$
- Output current: |IOH|/IOL = 24 mA (min) (VCC = 3.0 V)
- Latch-up performance: ±500 mA
- Package: TSSOP (thin shrink small outline package)
- Power-down protection provided on all inputs and outputs

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#### Pin Assignment (top view)



## **IEC Logic Symbol**



## **Truth Table**

Inp	Outputs	
1OE	1A1-1A4	1Y1-1Y4
L	L	L
L	Н	Н
Н	Х	Z

Inp	Outputs	
2 <del>OE</del>	2A1-2A4	2Y1-2Y4
L	L	L
L	Н	Н
Н	Х	Z

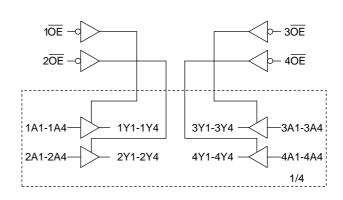
Inp	Outputs	
3 <del>OE</del>	3A1-3A4	3Y1-3Y4
L	L	L
L	Н	Н
Н	Х	Z

Inp	Outputs	
4 <del>OE</del>	4A1-4A4	4Y1-4Y4
L	L	L
L	Н	Н
Н	Х	Z

X: Don't care

Z: High impedance

# **System Diagram**





#### **Maximum Ratings**

Characteristics	Symbol	Rating	Unit
Power supply voltage	$V_{CC}$	-0.5 to 6.0	V
Input voltage	$V_{IN}$	-0.5 to 7.0	V
Output voltage	V	-0.5 to 7.0 (Note 1)	V
Output voltage	V <sub>OUT</sub>	$-0.5$ to $V_{CC} + 0.5$ (Note 2)	V
Input diode current	I <sub>IK</sub>	-50	mA
Output diode current	lok	±50 (Note 3)	mA
DC output current	lout	±50	mA
Power dissipation	$P_{D}$	400	mW
DC V <sub>CC</sub> /ground current per supply pin	I <sub>CC</sub> /I <sub>GND</sub>	±100	mA
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note 1: Output in OFF state

Note 2: High or low state.  $I_{\mbox{OUT}}$  absolute maximum rating must be observed.

Note 3:  $V_{OUT} < GND, V_{OUT} > V_{CC}$ 

## **Recommended Operating Conditions**

Characteristics	Symbol	Rating	Unit	
Power supply voltage	Vaa	2.0 to 3.6	V	
Fower supply voltage	V <sub>CC</sub>	1.5 to 3.6 (Note 4)	V	
Input voltage	V <sub>IN</sub>	0 to 5.5	V	
Output voltage	V	0 to 5.5 (Note 5)	V	
Output voltage	Vout	0 to V <sub>CC</sub> (Note 6)		
		±24 (Note 7)		
Output current	I <sub>OH</sub> /I <sub>OL</sub>	±12 (Note 8)	mA	
		±8 (Note 9)		
Operating temperature	T <sub>opr</sub>	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 10 (Note 10)	ns/V	

Note 4: Data retention only

Note 5: Output in OFF state

Note 6: High or low state

Note 7:  $V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$ 

Note 8:  $V_{CC} = 2.7 \text{ to } 3.0 \text{ V}$ 

Note 9:  $V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$ 

Note 10:  $V_{IN} = 0.8$  to 2.0 V,  $V_{CC} = 3.0$  V



#### **Electrical Characteristics**

# DC Characteristics ( $Ta = -40 \text{ to } 85^{\circ}\text{C}$ )

Characteris	Characteristics Symbol Test Condition		Test Condition			Min	Max	Unit						
					V <sub>CC</sub> (V)									
	H-level	V <sub>IH</sub>	_	_	2.3 to 2.7	1.7	_							
Input voltage	Tricvei	VIН			2.7 to 3.6	2.0		V						
input voitage	L-level	VIL			2.3 to 2.7	_	0.7	V						
	L-level	V IL	_	_	2.7 to 3.6	_	0.8							
				I <sub>OH</sub> = -100 μA	2.3 to 3.6	V <sub>CC</sub> -0.2	_							
				$I_{OH} = -8 \text{ mA}$	2.3	1.8	_							
	H-level	V <sub>OH</sub>	$V_{IN} = V_{IH}$ or $V_{IL}$	I <sub>OH</sub> = -12 mA	2.7	2.2	_							
				I <sub>OH</sub> = -18 mA	3.0	2.4	_							
Output voltage				I <sub>OH</sub> = -24 mA	3.0	2.2	_	V						
				I <sub>OL</sub> = 100 μA	2.3 to 3.6	_	0.2							
				I <sub>OL</sub> = 8 mA	2.3	_	0.6							
	L-level	$V_{OL}$	$V_{IN} = V_{IH}$ or $V_{IL}$	$I_{OL} = 12 \text{ mA}$	2.7	_	0.4							
		i		I <sub>OL</sub> = 16 mA	3.0	_	0.4							
				I <sub>OL</sub> = 24 mA	3.0	_	0.55							
Input leakage curren	nt	I <sub>IN</sub>	V <sub>IN</sub> = 0 to 5.5 V		2.3 to 3.6	_	±5.0	μА						
3-state output off-sta	ato current	l	$V_{IN} = V_{IH}$ or $V_{IL}$		2.3 to 3.6		±5.0	μА						
3-state output oii-sta	ale current	l <sub>OZ</sub>	V <sub>OUT</sub> = 0 to 5.5 V		2.3 10 3.0		±3.0	μΑ						
Power off leakage co	urrent	I <sub>OFF</sub>	$V_{IN}/V_{OUT} = 5.5 \text{ V}$		$V_{IN}/V_{OUT} = 5.5 \text{ V}$		$V_{IN}/V_{OUT} = 5.5 \text{ V}$		V <sub>IN</sub> /V <sub>OUT</sub> = 5.5 V		0		10.0	μΑ
Quiescent supply cu	rront	$V_{IN} = V_{CC}$ or GND		2.3 to 3.6	_	20.0								
Quiescerit supply cu		Icc	V <sub>IN</sub> /V <sub>OUT</sub> = 3.6 to 5.5 V		2.3 to 3.6		±20.0	μΑ						
Increase in Icc per ir	nput	Δlcc	$V_{IH} = V_{CC} - 0.6 \ V$		2.3 to 3.6		500							

## AC Characteristics ( $Ta = -40 \text{ to } 85^{\circ}\text{C}$ )

Characteristics	Cumbal	nbol Test Condition V <sub>CC</sub> (V)			Min	Max	Unit
Characteristics	Symbol			C <sub>L</sub> (pF)	IVIIII	IVIAX	Unit
	t <sub>pLH</sub>		$2.5 \pm 0.2$	30	1.5	5.4	
Propagation delay time	<b>.</b>	Figure 1, Figure 2	2.7	50	1.5	5.2	ns
	t <sub>pHL</sub>		$3.3 \pm 0.3$	50	1.5	4.5	
	t		$2.5 \pm 0.2$	30	1.5	7.2	
3-state output enable time	t <sub>pZL</sub>	Figure 1, Figure 3	2.7	50	1.5	6.3	ns
	t <sub>pZH</sub>		$3.3\pm0.3$	50	1.5	5.5	
	<b>.</b>		$2.5 \pm 0.2$	30	1.5	6.5	
3-state output disable time	t <sub>pLZ</sub>	Figure 1, Figure 3	2.7	50	1.5	5.7	ns
	t <sub>pHZ</sub>		$3.3\pm0.3$	50	1.5	5.4	
			$2.5 \pm 0.2$	30	_	_	
Output to output skew	t <sub>osLH</sub>	(Note 11)	2.7	50	_	_	ns
	t <sub>osHL</sub>		$3.3 \pm 0.3$	50		1.0	

Note 11: Parameter guaranteed by design.  $(t_{OSLH} = |t_{DLHm} - t_{DLHn}|, \, t_{OSHL} = |t_{DHLm} - t_{DHLn}|)$ 

## **Dynamic Switching Characteristics**

(Ta = 25°C, input:  $t_r = t_f = 2.5$  ns,  $R_L = 500$  Ω)

Chamataviation		Comple al	Test Condition		T	l lait
Characteristics		Symbol	rest Condition	V <sub>CC</sub> (V)	Тур.	Unit
Quiet output maximum	V <sub>OL</sub>	V <sub>OLP</sub>	$V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}, C_L = 30 \text{pF}$	2.5	0.6	V
dynamic	VOL	VOLP	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}, C_L = 50 \text{pF}$	3.3	8.0	V
Quiet output minimum	Vo	V <sub>OLV</sub>	$V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}, C_L = 30 \text{pF}$	2.5	0.6	V
dynamic	$V_{OL}$	IVOLVI	V <sub>IH</sub> = 3.3 V, V <sub>IL</sub> = 0 V, C <sub>L</sub> =50pF	3.3	0.8	V

## **Capacitive Characteristics (Ta = 25°C)**

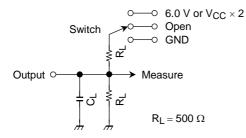
Characteristics	Symbol	Test Condition		V <sub>CC</sub> (V)	Тур.	Unit
Input capacitance	C <sub>IN</sub>	_		3.3	7	pF
Output capacitance	C <sub>OUT</sub>	_		3.3	8	pF
Power dissipation capacitance	C <sub>PD</sub>	$f_{IN} = 10 \text{ MHz}$	Note 12)	3.3	25	pF

Note 12: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/16 \text{ (per bit)}$ 

#### **AC Test Circuit**



Parameter	Switch		
t <sub>pLH</sub> , t <sub>pHL</sub>	Open		
t <sub>pLZ</sub> , t <sub>pZL</sub>	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$		
t <sub>pHZ</sub> , t <sub>pZH</sub>	GND		

Figure 1

#### **AC Waveform**

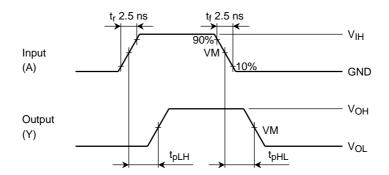


Figure 2 t<sub>pLH</sub>, t<sub>pHL</sub>

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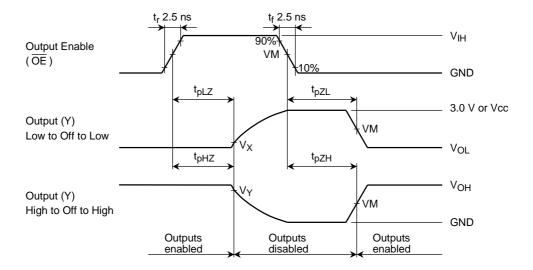


Figure 3  $t_{pLZ}$ ,  $t_{pHZ}$ ,  $t_{pZL}$ ,  $t_{pZH}$ 

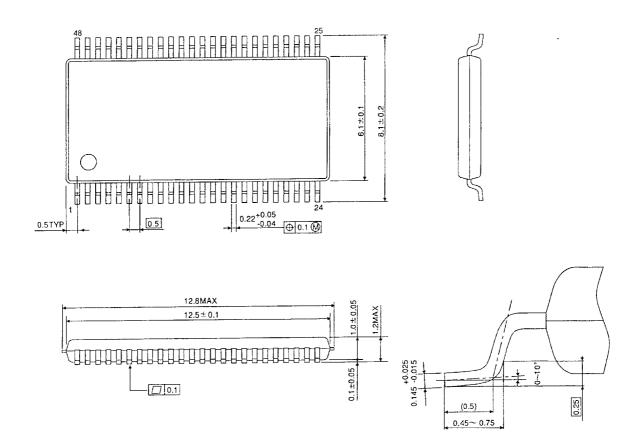
Symbol		V <sub>CC</sub>	
Syllibol	$3.3\pm0.3~\textrm{V}$	2.7 V	$2.5\pm0.2~\textrm{V}$
V <sub>IH</sub>	2.7 V	2.7 V	V <sub>CC</sub>
V <sub>M</sub>	1.5 V	1.5 V	V <sub>CC</sub> /2
VX	V <sub>OL</sub> + 0.3 V	V <sub>OL</sub> + 0.3 V	V <sub>OL</sub> + 0.15 V
VY	V <sub>OH</sub> – 0.3 V	V <sub>OH</sub> – 0.3 V	V <sub>OH</sub> – 0.15 V

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## **Package Dimensions**

TSSOP48-P-0061-0.50 Unit: mm



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Weight: 0.25 g (typ.)

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